

# QE for Capacitive Touch V4.3.0

## Release Note

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Thank you very much for using the QE for Capacitive Touch V4.3.0.

This release note covers product installation, restrictions, and so on. Please read this document before using the product.

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# 1. About QE for Capacitive Touch

## 1.1 Summary

QE for Capacitive Touch is an assistance tool for applications and operates under the e<sup>2</sup> studio integrated development environment. In the development of an embedded system based on an RX family, RA family, RL78 family or Renesas Synergy MCU that incorporates the capacitive touch sensing unit (hereafter the CTSU), this product facilitates the easy initialization of touch interfaces and tuning of their sensitivity, thus reducing development times.

To use this product, you will first need to add a project for the RX family, RA family, RL78 family or Renesas Synergy MCU and the capacitive touch sensor-related CTSU driver and Touch middleware.

## 1.2 Functions

The three functions below make it easy to develop applications that involve capacitive touch sensors.

1. Creating touch interface configurations
2. Tuning
3. Monitoring and parameter adjustment

Also, it is easy to develop gesture applications using e-AI. QE's three functions, "recording function", "AI generation function", and "monitoring and tuning function", support AI application development, which is a difficult process with many steps. Anyone can develop AI applications without the need for specialized AI skills

## 1.3 New Functions

### 1.3.1 Diagnostic Function Improvements (CTSU2)

Improved diagnostic functions for CTSU2 devices. For details on the diagnostic functions, please refer to the application note below.

- [RX Family QE CTSU module Firmware Integration Technology](#)
- [RL78 Family CTSU Module Software Integration System](#)

\* To use the diagnostic function, a touch I/F other than the "Shield Pin," "Temperature Compensation Pin," "Current Sensor," or "MEC" is required.

### 1.3.2 Changes to Advanced Mode Settings

The following changes were made to Advanced Mode settings.

#### 1.3.2.1 Transmit Power Setting (CTSU2)

1. The name of the transmit power supply setting item "VCC" was changed to the correct name for each device.

Device	Before	After
RX	VCC	VCC
RA / Synergy		VCC/AVCC
RL78		VDD/EVDD

2. Default settings when selecting "Auto" were reviewed.

Touch interface configuration	Before	After

Self-capacitance (no shield pin)	VCC	Internal logic power supply
Self-capacitance (with shield pin)	Internal logic power supply	Internal logic power supply
Others	VCC (private)	VCC (private)

Note: Only the “Self-capacitance (no shield pin)” setting was changed.

### 1.3.2.2 Base Clock Frequency / Sensor Drive Pulse Frequency Setting (Slider/Wheel)

The configuration has been improved so that when the base clock frequency or sensor-drive pulse frequency of any TS pin used for a slider or wheel is modified, the same settings are automatically applied to all other TS pins that constitute the slider or wheel.

### 1.3.2.3 Measurement Time Setting

Improved so that an error is generated if a measurement time that may cause measurement value overflow is set.

### 1.3.3 Bug Fixes

The following issues were fixed:

1. When the touch interface configuration is changed in the CapTouch Workflow (QE) view after tuning, the capacitance values displayed in the CapTouch Multi Status Chart (QE) view were incorrect.
2. The frequency value displayed in the Advanced Mode base clock setting for CTSU1 devices was incorrect.
3. The notes for measurement result of CTSU driver and the tuning feature of this product, as described in Tool News (R20TS1229EJ0100), have been resolved.

### 1.3.4 Improvements to Usage Considerations

The following usage considerations described in the QE for Capacitive Touch V4.2.0 release note were improved:

1. Removed SNRSUM value from standard deviation measurement results because it is for reference only. (V4.2.0 Release Notes Section 3.1.4)
2. Improved so that the actual sensor drive pulse frequency is displayed in the sensor drive pulse frequency field in the CapTouch Board Monitor (QE) view. (V4.2.0 Release Notes Section 3.1.4)
3. Improved sample code for using the diagnostic function together with the DTC function. (V4.2.0 Release Notes Section 3.1.10)
4. Improved an issue where the CapTouch Workflow (QE) view displayed incorrectly. (V4.2.0 Release Notes Section 3.1.15)
5. Improved an issue where e<sup>2</sup> studio might not start when an RA device project is selected in the CapTouch Workflow (QE) view. (V4.2.0 Release Notes Section 3.1.16)

## 1.4 Supported Environments

### 1.4.1 For Plugin Version

Windows 11

Renesas e<sup>2</sup> studio 2025-12

\* If you are using a version of the e<sup>2</sup> studio 2025-07 or earlier, please update it to 2025-12.

## 1.4.2 For Standalone Version

Windows 11

## 1.5 Confirmed Debugging Tools

- RX Family
  - E2 emulator
  - E2 emulator Lite
  - J-Link
- RA Family
  - E2 emulator
  - E2 emulator Lite
  - J-Link
- RL78 Family
  - E2 emulator
  - E2 emulator Lite
- Renesas Synergy
  - J-Link

## 1.6 Supported Microcontrollers

- RX Family (only MCUs that incorporate the CTSU)
  - RX100 Series: RX113, RX130, RX140
  - RX200 Series: RX230, RX231, RX23W, RX260, RX261
  - RX600 Series: RX671
- RA Family (only MCUs that incorporate the CTSU)
  - RA0 Series: RA0L1
  - RA2 Series: RA2A1, RA2E1, RA2L1
  - RA4 Series: RA4L1, RA4M1, RA4M2, RA4M3, RA4W1
  - RA6 Series: RA6M1, RA6M2, RA6M3, RA6M4, RA6M5
- RL78 Family (only MCUs that incorporate the CTSU)
  - RL78/F22
  - RL78/F25
  - RL78/G16
  - RL78/G22
  - RL78/G23
  - RL78/L23
- Renesas Synergy (only MCUs that incorporate the CTSU)
  - S1 Series: S124, S128, S1JA
  - S3 Series: S3A1, S3A3, S3A6, S3A7
  - S5 Series: S5D3, S5D5, S5D9
  - S7 Series: S7G2

## 1.7 Supported Software

- Driver and middleware for capacitive touch sensor
  - RX Firmware Integration Technology (FIT)
    - CTSU driver: r\_ctsu\_qe V3.30
    - Touch middleware: rm\_touch\_qe V3.30
  - RA Flexible Software Package (FSP)
    - CTSU driver: r\_ctsu V6.4.0
    - Touch middleware: rm\_touch V6.4.0
    - Note: If you use diagnostic function, please use the next version.
  - RL78 Software Integration System (SIS)
    - CTSU driver: r\_ctsu V2.30
    - Touch middleware: rm\_touch V2.30
  - Renesas Synergy Software Package (SSP)
    - CTSU driver: r\_ctsuv2 V2.6.0
    - Touch framework: sf\_touch\_ctsuv2 V2.6.0

## 2. Installation and Uninstallation

### 2.1 Installing This Product

Use either of the following procedure to install this product.

#### 2.1.1 Install from the "Renesas Software Installer" menu of e<sup>2</sup> studio

1. Start e<sup>2</sup> studio.
2. Select the "Renesas Views" – "Renesas Software Installer" menu of e<sup>2</sup> studio to open the "Renesas Software Installer" dialog box.
3. Select the "Renesas QE" and click the "Next>" button
4. Select the "QE for Capacitive Touch (v4.3.0)" check box, and click the "Finish" button.
5. Check that the "Renesas QE for Capacitive Touch" check box is selected in the "Install" dialog box, and click the "Next>" button.
6. Check that the "Renesas QE for Capacitive Touch" check box is selected as the target of installation, and click the "Next>" button.
7. After confirming the license agreements, if you agree to the license, select the "I accept the terms of the license agreements" radio button, and click the "Finish" button.
8. If the dialog of the trust certificate is displayed, check that certificate, and click the "OK" button to continue installation.
9. When prompted to restart e<sup>2</sup> studio, restart it.
10. Start this product from the "Renesas Views" - "Renesas QE" menu of e<sup>2</sup> studio. For details about how to use this product, see the "Help" menu of e<sup>2</sup> studio.

#### 2.1.2 Install using QE (zip file) downloaded from the Renesas website

A downloaded zip file has both a plugin version and a standalone version.

##### 2.1.2.1 Install Plugin Version

1. Extract the downloaded zip file.
2. Start the e<sup>2</sup> studio.
3. Click on "Help", and then click on the "Install New Software..." menu item to open the "Install" dialog box.
4. Click on the "Add..." button to open the "Add Repository" dialog box.
5. Click on the "Archive..." button, select the installation file (zip file under the QE-CapTouch folder) in the opened file selection dialog box, and then click on the "Open" button.
6. Click on the "OK" button in the "Add Repository" dialog box.
7. Expand the "Renesas QE" item shown in the "Install" dialog box, select the "Renesas QE for Capacitive Touch" check box, and then click on the "Next>" button.  
\* If you check off the "Contact all update sites during install to find required software" checkbox, you can shorten the installation time.
8. Confirm that the installation target is "Renesas QE for Capacitive Touch", and then click on the "Next>" button.
9. After checking the license, select the "I accept the terms of the license agreements" radio button if you agree it, and then click on the "Finish" button.
10. When the dialog box for selecting a trusted certificate appears, check the displayed certificate, and then click on the "OK" button to continue installation.
11. Restart the e<sup>2</sup> studio by following the instructions on the screen.
12. Start this product from the "Renesas Views" - "Renesas QE" menu of the e<sup>2</sup> studio.

### 2.1.2.2 Install Standalone Version

1. Extract the downloaded zip file.
2. Move the QE-CapTouch folder to any folder.
  - \* Avoid moving to the Windows folder or Program Files folder or folders whose name contain spaces.
3. Start this product from the "QE-CapTouch\eclipse\qe-captouch.exe" file.

## 2.2 Updating This Product (for Plugin Version)

If you have already installed this product, you can update it in the same way as the procedure for installation 2.1.2.1.

## 2.3 Uninstalling This Product

Follow the procedure below to uninstall this product.

### 2.3.1 Uninstall Plugin Version

1. Start the e<sup>2</sup> studio.
2. Select "Help -> About e<sup>2</sup> studio" to open the "About e<sup>2</sup> studio" dialog box.
3. Click the "Installation Details" button to open the "e<sup>2</sup> studio Installation Details" dialog box.
4. Select "Renesas QE for Capacitive Touch" displayed on the "Installed Software" tabbed page and click on the "Uninstall..." button to open the "Uninstall" dialog box.
5. Check the displayed information and click on the "Finish" button.
6. When you are prompted to restart the e<sup>2</sup> studio, restart it.

### 2.3.2 Uninstall Standalone Version

1. Delete the QE-CapTouch folder.

### 3. Notes / Restrictions

#### 3.1 Usage Considerations

Please pay attention to the following items.

##### 3.1.1 Notes on the clock supplied to the CTSU

1. Ensure that the clock supplied to CTSU (PCLKB or fCLK) is set to the following frequencies or higher. Lower frequencies are not supported.
  - CTSU: 8MHz
  - CTSU2: 1MHz

##### 3.1.2 Notes on RA4L1 Usage

1. When using RA4L1 at an ambient temperature over 85°C, the sensor drive pulse frequency set by the tuning touch sensors of the QE for Capacitive Touch may be too high, resulting in inaccurate measurements.  
If the measurement values are small or unstable, this may be the case. Consider lowering the sensor drive pulse frequency to obtain stable measurement values.

##### 3.1.3 Notes on Tuning

1. If there are multiple debugging configurations in the target project, automatic tuning may fail. Please check whether it is possible to debug the target board using the IDE's function. If there are multiple debugging configurations in the target project, the configurations used for debugging in the last time is chosen to automatic tuning. If the debug configuration used in last time is different from the project for automatic tuning, QE cannot start debugging. Before starting automatic tuning, please debug target project once.
2. When the "Automatic Tuning Processing" dialog box is waiting for key input, pressing the "Cancel" / "Help" button is not possible.
3. When using a board without a sub-clock (e.g. Capacitive Touch Evaluation System for RA2L1), the project is not executed up to the main() function and the tuning function cannot be used. Change the FSP's "BSP" property – "Subclock Populated" setting to "Not Populated".
4. When using RL78/G22, the tuning function cannot be used for touch I/F configuration that include current sensor.
5. Do not use the Watchdog Timer (WDT) when using the tuning function. Since the WDT counter is not cleared during tuning, the counter may overflow, causing a reset. This will result in tuning failure.
6. When using serial communication for tuning, tuning cannot start if the timer interrupt in the user program conflicts with the UART receive interrupt used in the tuning process. Please either increase the priority of the UART receive interrupt or avoid using the timer.
7. The following touch I/F are not supported for tuning via serial communication:
  - 3D Gesture
  - Touch Pad
  - Current Sensor
8. When performing tuning using serial communication with a touch I/F configuration in which touch judgment (SMS) is enabled, follow the procedure below:
  - In the Create Configuration of Touch Interfaces dialog, disable touch judgment (SMS).
  - Output files required for a tuning process.
  - In the Create Configuration of Touch Interfaces dialog, enable touch judgment (SMS).
  - Perform tuning.

### 3.1.4 Notes on Monitoring

1. When monitoring using serial communication on the RX family, set the TX buffer size of the SCI FIT module (`r_sci_rx`) to the same size as the QE monitoring buffer (`g_touch_monitor_buf`). The QE monitoring buffer size is the value defined by the `TOUCH_MONITOR_BUFFER_SIZE` macro.
2. For RL78 Family, the emulator has a low data rate, and as the number of buttons increases, monitoring using the emulator becomes impossible. In such cases, please use serial communication for monitoring.
3. If you need to perform memory access while monitoring using serial communication on RL78/G16, the following settings are required.
  - Set "Pseudo-RRM/DMM function setting" to "Used" in Smart Configurator.
  - In the C/C++ build settings of the project, set the address in "Tool Settings" – "Linker" – "Device" – "Reserve working memory for RRM/DMM function (-rrm)" so that the first 4 bytes of RAM are not used.
  - In the debug configuration, set "Debugger" - "Debug Tool Settings" - "Allow to access by stopping execution while running" to "Yes".
4. In the CapTouch Parameters (QE) view, the contents may not be displayed after selecting a Touch I/F.  
Please close the CapTouch Parameters (QE) view once and then reopen it.
5. In the CapTouch Parameters (QE) view, when writing multiple parameters to the target board at once, some parameters may not be written successfully.  
Please try writing to the target board again.

### 3.1.5 Notes on Serial Connection

1. Before connecting to the Fast Prototyping Board (FPB) using a serial port, please see the documentation that came with the FPB and the user's manual of the FPB.

### 3.1.6 Notes on creating touch interface configuration

1. The RAM size of the MCU may be exceeded depending on the number of touch interfaces (buttons, sliders, wheels, etc.). Please create the touch interface configuration considering the amount of memory used by the touch function and the user program. Pay particular attention to MCU, which has a maximum RAM size of 2 KB.
2. When importing a touch interface configuration across different MCU, please review the touch interface configuration again after import.

### 3.1.7 Notes on Standalone Version

1. It may be slow to enable / disable the internal toolbar buttons of each view. Please move the focus to another view once.
2. The 3D gesture recognition is not available in the standalone version. Please use the plugin version.

### 3.1.8 Notes on TrustZone

1. The tuning processing using an emulator cannot be performed on the non-secure side. Please perform one of the following:
  - Perform tuning using serial communication.
  - Perform tuning using an emulator on the secure side and use results on the non-secure side.

- Monitoring of hardware touch judgment is not supported.

### 3.1.9 Notes on Hardware Touch Judgment Function

- If you are using only the hardware touch judgment function and not using software judgement, please do not add the touch middleware in the smart configurator. For usage examples, please refer to the sample code provided by QE for Capacitive Touch.
- When using the hardware touch judgment function, tuning and monitoring using serial communication are not available.
- Even when you start monitoring, there may be cases where the monitoring data is not updated. After pausing and resuming the program, please start monitoring again.
- When using hardware touch judgment with the RA family, set the [Number of Transfer Descriptors] in the FSP DTC module (`g_transfer0` / `g_transfer1`) to the following values.

	<code>g_transfer0</code>	<code>g_transfer1</code>
Hardware touch judgment (VMM)	8	5
Hardware touch judgment (JMM)	6	5
Hardware touch judgment (VMM + JMM)	8	5

- When the touch threshold or hysteresis value is changed in the CapTouch Parameters view and then written to the target board, the value may not change to the specified value or may change to a value different from the specified value.  
In the case of touch threshold, change the hysteresis value to a sufficiently small value before writing.  
In case of hysteresis, please change the value of touch threshold to a sufficiently large value before writing.
- When using hardware touch judgment function with QE for Capacitive Touch V4.0.0, please use RX FIT V3.00 or later and RL78 SIS V2.0.0 or later.
- For RX260 and RX261, the "VMM" can be selected for hardware touch judgment, but it is not available in RX FIT V3.00. Please use RX FIT V3.10 or later.

### 3.1.10 Notes on CapTouch Workflow (QE) View

- If you press the "Maximize"/"Restore" button in the e<sup>2</sup> studio window while playing a tutorial video with the video window maximized, you will not be able to maximize the video window again.  
Close and re-open the CapTouch Workflow (QE) view.
- The workflow cannot be opened if WebView2 Runtime is not installed on your PC.  
Download and install WebView2 (x64 version) from the Microsoft web page. (FAQ:[3000670](#))
- If you close e<sup>2</sup> studio while the display screen is being created when opening the CapTouch Workflow (QE) view, the background process may not terminate and e<sup>2</sup> studio may not launch. In that case, end the e<sup>2</sup> studio.exe task in the background processes via Task Manager.

### 3.1.11 Notes on View Operation

- When floating (detaching from e<sup>2</sup> studio) each view in QE for Capacitive Touch, it may not function correctly.  
Please use each view without floating.
- When the following operations are performed, multiple instances of the CapTouch Status Chart view may be displayed. In this case, please reset the CapTouch Monitor (QE) perspective.
  - Display the CapTouch Status Chart (QE) view in the editor area without the CapTouch Monitor (QE) perspective being added.
  - Add the CapTouch Monitor (QE) perspective afterward.

### 3.1.12 Notes on Using Renesas Synergy Projects

1. When using e<sup>2</sup> studio 2023-01 or later, an error indicating that an invalid touch sensor is assigned will be displayed during the creation of a touch interface configuration, preventing the configuration from being created.  
Please use one of the following methods to create the configuration:
  - Create the touch interface configuration on QE before adding the Touch SSP module on Smart Configurator.
  - Use e<sup>2</sup> studio 2022-10.

### 3.1.13 Notes on Installation

1. When installing QE for Capacitive Touch V3.5.0 or later plugin version, the “Trust Artifacts” dialog box displays the QE for Capacitive Touch plugin as unsigned.  
Check “Unsigned” and click the “Trust Selected” button to continue the installation.

### 3.1.14 Notes on Help Window Operations

1. While a modal dialog is displayed, the help window cannot be operated.  
Please operate the Help window using one of the following methods:
  - Close the modal dialog once, and then operate the Help window.
  - Configure the Help window to open in an external browser using the following settings:  
Open the [Window] → [Preferences...] menu to display the Preferences dialog. Select [Help], and set [Open help contents] to “In an external browser.”

### 3.1.15 Notes on Display Scaling Settings

1. Depending on the display scaling setting, the GUI of this product may not be displayed correctly. In that case, set Windows display scaling to “100%.”
2. If multiple displays are used and their scaling settings differ, moving e<sup>2</sup> studio to a different display may prevent correct operation (e.g., clicking a touch interface does not select it). In that case, use e<sup>2</sup> studio on the display where it was launched, or set the scaling to the same value for all displays.

## 3.2 Functional Restrictions

There are restrictions in QE for Capacitive Touch V4.3.0.

### 3.2.1 Restrictions on Standalone Version

1. Help files are not existed.

### 3.2.2 Restrictions on RL78/G16 Monitoring Function

1. When using RL78/G16, monitoring using an emulator is not available. Please use serial communication for monitoring.  
When debugging by memory access during monitoring, refer to 3.1.4 Notes on Monitoring.

### 3.2.3 Restrictions on Tuning

1. When performing tuning using an emulator on the RL78 family, please ensure that the debug stack area does not overlap with the tuning RAM program area. If these areas overlap, tuning will not be performed correctly.

For more details about the debug stack area, refer to the " On-chip Debugging" section in the RL78 microcontroller's User Manual: Hardware.

The tuning RAM program area is allocated as follows: (QE for Capacitive Touch writes and executes the tuning program in the RAM area).

- RL78/F22: 0xFD530 – 0xFF130
- RL78/F25: 0xFD530 – 0xFF130
- RL78/G22: 0xFEF00 – 0xFFE00
- RL78/G23: 0xFCF00 – 0xFEB00
- RL78/L23: 0xFCF00 – 0xFEC00

## 4. Related Videos

Many videos about this product are published in the Renesas website.

- Getting Started with QE for Capacitive Touch for RX (old version)  
— <https://www.renesas.com/video/getting-started-qe-capacitive-touch>
- Getting Started with QE for Capacitive Touch for RL78  
— <https://www.renesas.com/video/getting-started-qe-capacitive-touch-rl78>
- Getting Started with QE for Capacitive Touch for RA  
— <https://www.renesas.com/us/en/video/getting-started-qe-capacitive-touch-ra>
- QE for Capacitive Touch [Tutorial -Settings-] for RX (old version)  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-settings>
- QE for Capacitive Touch [Tutorial -Tuning-] for RX (old version)  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-tuning>
- QE for Capacitive Touch [Tutorial -Monitoring-] for RX (old version)  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-monitoring>
- QE for Capacitive Touch Tutorial: Settings for RL78  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-settings-rl78>
- QE for Capacitive Touch Tutorial: Tuning for RL78  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-tuning-rl78>
- QE for Capacitive Touch Tutorial: Serial Monitoring for RL78  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-serial-monitoring-rl78>
- QE for Capacitive Touch Tutorial: Step 1 Configuration for RA  
— <https://www.renesas.com/us/en/video/qe-capacitive-touch-tutorial-step-1-configuration-ra>
- QE for Capacitive Touch Tutorial: Step 2 Tuning for RA  
— <https://www.renesas.com/us/en/video/qe-capacitive-touch-tutorial-step-2-tuning-ra>
- QE for Capacitive Touch Tutorial: Step 3 Monitoring for RA  
— <https://www.renesas.com/us/en/video/qe-capacitive-touch-tutorial-step-3-monitoring-ra>
- QE for Capacitive Touch Feature - Measuring Standard Deviation  
— <https://www.renesas.com/video/qe-capacitive-touch-feature-measuring-standard-deviation>
- QE for Capacitive Touch Feature - Check Monitoring Values Using The Monitoring Log Feature  
— <https://www.renesas.com/video/qe-capacitive-touch-feature-check-monitoring-values-using-monitoring-log-feature>
- QE for Capacitive Touch Feature - Two Types of Touch Judgment Modes with CTSU2 and QE  
— <https://www.renesas.com/video/qe-capacitive-touch-feature-two-types-touch-judgment-modes-ctsu2-and-qe>
- QE for Capacitive Touch Feature - Two Types of Touch Judgment with CTSU2S and QE  
— <https://www.renesas.com/video/qe-capacitive-touch-feature-two-types-touch-judgment-ctsu2s-and-qe>
- QE for Capacitive Touch Feature – A New Workflow Diagram in QE V3.2.0.  
— <https://www.renesas.com/us/en/video/qe-capacitive-touch-feature-new-workflow-diagram-qe-v320>
- QE for Capacitive Touch Tips - Warning Message Appeared During Tuning  
— <https://www.renesas.com/video/qe-capacitive-touch-tips-warning-message-appeared-during-tuning>
- How to tune via serial communication using the standalone app of QE.  
— <https://www.renesas.com/video/how-tune-serial-communication-using-standalone-app-qe>
- How to migrate the touch modules from version 1.1 to version 2.0 using the compatible APIs with QE tool.  
— <https://www.renesas.com/video/how-migrate-touch-modules-version-11-version-20-using-compatible-apis-qe-tool>
- QE for Capacitive Touch Tutorial: How to Tune via Serial Communication Using the Plug-in  
— <https://www.renesas.com/us/en/video/qe-capacitive-touch-tutorial-how-tune-serial-communication-using-plug>
- 3D Gesture AI Solution - QE for Capacitive Touch Makes It Easy To Develop a Contactless User Interface  
— <https://www.renesas.com/video/3d-gesture-ai-solution-qe-capacitive-touch-makes-it-easy-develop-contactless-user-interface>

- QE for Capacitive Touch Tutorial: How to create the gesture data  
— <https://www.renesas.com/video/qe-capacitive-touch-tutorial-how-create-gesture-data>
- QE for Capacitive Touch Tutorial: How to monitor gesture AI  
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The SBOM is created in SPDX Lite format and is included in the zip archive distributed together with this release note.

**Revision History**

Rev.	Date	Description	
		Page	Summary
1.00	Mar.24.26	-	First edition issued.
1.10	Apr.06.26	4	Added Tool News (R20TS1229EJ0100) resolution to 1.3.3 Bug Fixes.
		12	Added a workaround using an external browser to 3.1.14 Notes on Help Window Operations.
1.20	Apr.20.26	17	Added 6. About the Software Bill of Materials (SBOM)

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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